# NX3DV2567

## Low-ohmic four-pole double-throw analog switch

Rev. 2 — 9 November 2011

**Product data sheet** 

### 1. General description

The NX3DV2567 is a four-pole double-throw analog switch (4PDT) optimized for switching WLAN-SIM supply, data and control signals. It has one digital select input (S) and four switches each with two independent input/outputs (nY0 and nY1) and a common input/output (nZ). Schmitt trigger action at S makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 1.4 V to 4.3 V.

A low input voltage threshold allows pin S to be driven by lower level logic signals without significant increase in supply current  $I_{CC}$ . This makes it possible for the NX3DV2567 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation.

The NX3DV2567 allows signals with amplitude up to  $V_{CC}$  to be transmitted from nZ to nY0 or nY1; or from nY0 or nY1 to nZ..

#### 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance for supply path:
  - 0.5  $\Omega$  (typical) at  $V_{CC} = 1.8 \text{ V}$
  - 0.45 Ω (typical) at V<sub>CC</sub> = 2.7 V
- Low ON resistance for data path:
  - 7  $\Omega$  (typical) at  $V_{CC} = 1.8 \text{ V}$
  - 6 Ω (typical) at V<sub>CC</sub> = 2.7 V
- Low ON capacitance for data path
- Wide –3 db bandwidth > 160 MHz
- Break-before-make switching
- High noise immunity
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 4000 V
  - ◆ HBM JESD22-A114F Class 3A I/O to GND exceeds 7000 V
  - ◆ CDM AEC-Q100-011 revision B exceeds 1000 V
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply for supply path switch)



#### Low-ohmic four-pole double-throw analog switch

■ Specified from -40 °C to +85 °C and from -40 °C to +125 °C

## 3. Applications

- Cell phone, PDA, digital camera, printer and notebook
- LCD monitor, TV and set-top box

### 4. Ordering information

#### Table 1. Ordering information

| Type number | Package           |          |  |           |
|-------------|-------------------|----------|--|-----------|
|             | Temperature range | Name     | Description  | Version   |
| NX3DV2567HR | –40 °C to +125 °C | HXQFN16U | plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; UTLP based; body 3 x 3 x 0.5 mm | SOT1039-1 |
| NX3DV2567GU | –40 °C to +125 °C | XQFN16   | plastic, extremely thin quad flat package; no leads;<br>16 terminals; body 1.80 x 2.60 x 0.50 mm                   | SOT1161-1 |

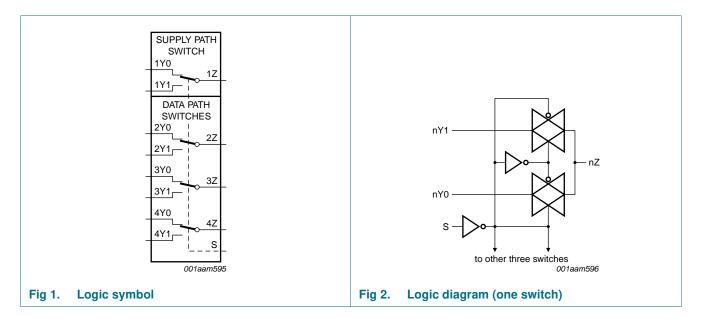
## 5. Marking

#### Table 2. Marking codes

| Type number | Marking code |
|-------------|--------------|
| NX3DV2567HR | D60          |
| NX3DV2567GU | D60          |

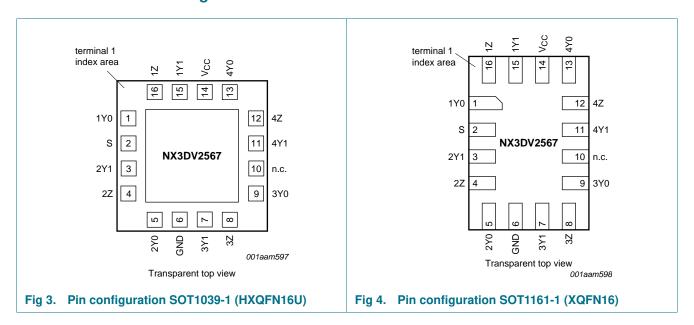
Low-ohmic four-pole double-throw analog switch

## 6. Functional diagram



## 7. Pinning information

#### 7.1 Pinning



#### Low-ohmic four-pole double-throw analog switch

### 7.2 Pin description

Table 3. Pin description

| Symbol          | Pin      | Description                                 |
|-----------------|----------|---|
| 1Y0             | 1        | independent input or output (supply switch) |
| 2Y0, 3Y0, 4Y0   | 5, 9, 13 | independent input or output (data switch)   |
| S               | 2        | select input                                |
| 1Y1             | 15       | independent input or output (supply switch) |
| 2Y1, 3Y1, 4Y1   | 3, 7, 11 | independent input or output (data switch)   |
| 1Z              | 16       | common output or input (supply switch)      |
| 2Z, 3Z, 4Z      | 4, 8, 12 | common output or input (data switch)        |
| GND             | 6        | ground (0 V)                                |
| n.c.            | 10       | not connected                               |
| V <sub>CC</sub> | 14       | supply voltage                              |

## 8. Functional description

Table 4. Function table[1]

| Input S | Channel on |
|---------|------------|
| L       | nY0        |
| Н       | nY1        |

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level.

## 9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min               | Max            | Unit |
|------------------|-------------------------|--|-------------------|----------------|------|
| $V_{CC}$         | supply voltage          |  | -0.5              | +4.6           | V    |
| VI               | input voltage           | select input S   | <u>[1]</u> –0.5   | +4.6           | V    |
| $V_{SW}$         | switch voltage          |  | [ <u>2</u> ] –0.5 | $V_{CC} + 0.5$ | V    |
| I <sub>IK</sub>  | input clamping current  | $V_1 < -0.5 \text{ V}$   | -50               | -              | mA   |
| I <sub>SK</sub>  | switch clamping current | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$  | -                 | ±50            | mA   |
| I <sub>SW</sub>  | switch current          | supply path switch   |                   |                |      |
|                  |                         | $V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current                      | -                 | ±350           | mA   |
|                  |                         | $V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current | -                 | ±500           | mA   |
|                  |                         | data path switch   |                   |                |      |
|                  |                         | $V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current                      | -                 | ±128           | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65               | +150           | °C   |

#### Low-ohmic four-pole double-throw analog switch

Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min      | Max | Unit |
|------------------|-------------------------|--|----------|-----|------|
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ | [3][4] _ | 250 | mW   |

- [1] The minimum input voltage rating may be exceeded if the input current rating is observed.
- [2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.
- [3] For HXQFN16U package: above 135 °C the value of Ptot derates linearly with 16.9 mW/K.
- [4] For XQFN16 package: above 133 °C the value of Ptot derates linearly with 14.5 mW/K.

### 10. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol              | Parameter                           | Conditions                       | Min          | Max      | Unit |
|---------------------|-------------------------------------|----------------------------------|--------------|----------|------|
| $V_{CC}$            | supply voltage                      |                                  | 1.4          | 4.3      | V    |
| VI                  | input voltage                       | select input S                   | 0            | 4.3      | V    |
| $V_{SW}$            | switch voltage                      |                                  | <u> 11</u> 0 | $V_{CC}$ | V    |
| T <sub>amb</sub>    | ambient temperature                 |                                  | -40          | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | V <sub>CC</sub> = 1.4 V to 4.3 V | [2] _        | 200      | ns/V |

<sup>[1]</sup> To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

#### 11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol          | Parameter                | Conditions  | T <sub>ar</sub> | <sub>nb</sub> = 25 | °C  | T <sub>amb</sub> = - | -40 °C to      | +125 °C         | Unit        |
|-----------------|--------------------------|---|-----------------|--------------------|-----|----------------------|----------------|-----------------|-------------|
|                 |                          |   | Min             | Тур                | Max | Min                  | Max<br>(85 °C) | Max<br>(125 °C) |             |
| V <sub>IH</sub> | HIGH-level               | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$                            | 0.9             | -                  | -   | 0.9                  | -              | -               | V           |
|                 | input voltage            | V <sub>CC</sub> = 1.65 V to 1.95 V                                    | 0.9             | -                  | -   | 0.9                  | -              | -               | V           |
|                 |                          | V <sub>CC</sub> = 2.3 V to 2.7 V                                      | 1.1             | -                  | -   | 1.1                  | -              | -               | V           |
|                 |                          | V <sub>CC</sub> = 2.7 V to 3.6 V                                      | 1.3             | -                  | -   | 1.3                  | -              | -               | ٧           |
|                 |                          | V <sub>CC</sub> = 3.6 V to 4.3 V                                      | 1.4             | -                  | -   | 1.4                  | -              | -               | ٧           |
| $V_{IL}$        | LOW-level                | V <sub>CC</sub> = 1.4 V to 1.6 V                                      | -               | -                  | 0.3 | -                    | 0.3            | 0.3             | V<br>V<br>V |
|                 | input voltage            | V <sub>CC</sub> = 1.65 V to 1.95 V                                    | -               | -                  | 0.4 | -                    | 0.4            | 0.3             | ٧           |
|                 |                          | V <sub>CC</sub> = 2.3 V to 2.7 V                                      | -               | -                  | 0.4 | -                    | 0.4            | 0.4             | ٧           |
|                 |                          | V <sub>CC</sub> = 2.7 V to 3.6 V                                      | -               | -                  | 0.5 | -                    | 0.5            | 0.5             | ٧           |
|                 |                          | V <sub>CC</sub> = 3.6 V to 4.3 V                                      | -               | -                  | 0.6 | -                    | 0.6            | 0.6             | V           |
| I <sub>I</sub>  | input leakage<br>current | select input S;<br>$V_I = GND$ to 4.3 V;<br>$V_{CC} = 1.4$ V to 4.3 V | -               | -                  | -   | -                    | ±0.5           | ±1              | μΑ          |

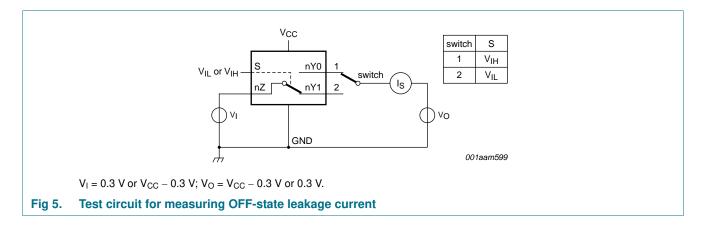
<sup>[2]</sup> Applies to control signal levels.

#### Low-ohmic four-pole double-throw analog switch

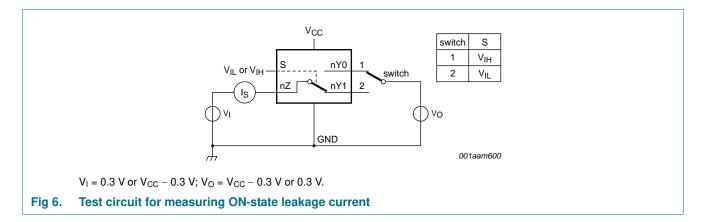
**Table 7. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

| Symbol              | Parameter                      | Conditions  | Ta  | <sub>mb</sub> = 25 | °C   | T <sub>amb</sub> = | –40 °C to      | +125 °C  | Unit                       |
|---------------------|--------------------------------|---|-----|--------------------|------|--------------------|----------------|--|----------------------------|
|                     |                                |   | Min | Тур                | Max  | Min                | Max<br>(85 °C) | Max<br>(125 °C)  |                            |
| $I_{S(OFF)}$        | OFF-state<br>leakage           | nY0 and nY1 port;<br>see <u>Figure 5</u>                                |     |                    | •    |                    |                |  |                            |
|                     | current                        | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$                              | -   | -                  | ±5   | -                  | ±50            | #500 n  ±500 n  ±500 n  ±500 n  5000 n  6000 n  7 μ  1 μ  15 μ  500 n  - p  - p  - p | nΑ                         |
|                     |                                | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$                              | -   | -                  | ±10  | -                  | ±50            | ±500   | nΑ                         |
| I <sub>S(ON)</sub>  | ON-state<br>leakage<br>current | nZ port;<br>$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$<br>see Figure 6 |     |                    |      |                    |                |  |                            |
|                     |                                | $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$                              | -   | -                  | ±5   | -                  | ±50            | ±500   | nΑ                         |
|                     |                                | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$                              | -   | -                  | ±10  | -                  | ±50            | ±500   | nΑ                         |
| I <sub>CC</sub>     | supply current                 | $V_I = V_{CC}$ or GND;<br>$V_{SW} = GND$ or $V_{CC}$                    |     |                    |      |                    |                |  |                            |
|                     |                                | $V_{CC} = 3.6 \text{ V}$  | -   | -                  | 100  | -                  | 500            | ±500 n/<br>5000 n/<br>6000 n/<br>7 μ/<br>1 μ/<br>15 μ/                               | nΑ                         |
|                     |                                | $V_{CC} = 4.3 \text{ V}$  | -   | -                  | 150  | -                  | 800            | 6000   | nA                         |
| $\Delta I_{CC}$     | additional                     | $V_{SW} = GND \text{ or } V_{CC}$                                       |     |                    |      |                    |                |  |                            |
|                     | supply current                 | $V_1 = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$                           | -   | 2.0                | 4.0  | -                  | 7              | 7  | μΑ                         |
|                     |                                | $V_1 = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$                           | -   | 0.35               | 0.7  | -                  | 1              | 1  | μΑ                         |
|                     |                                | $V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$                         | -   | 7.0                | 10.0 | -                  | 15             | 15   | nA<br>nA<br>nA<br>nA<br>nA |
|                     |                                | $V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$                         | -   | 2.5                | 4.0  | -                  | 5              | 5  | μΑ                         |
|                     |                                | V <sub>I</sub> = 1.8 V; V <sub>CC</sub> = 2.5 V                         | -   | 50                 | 200  | -                  | 300            | 500  | nΑ                         |
| Cı                  | input<br>capacitance           |   | -   | 1                  | -    | -                  | -              | -  | pF                         |
| C <sub>S(OFF)</sub> | OFF-state                      | supply path switch  | -   | 35                 | -    | -                  | -              | -  | pF                         |
|                     | capacitance                    | data path switch  | -   | 3                  | -    | -                  | -              | -  | pF                         |
| C <sub>S(ON)</sub>  | ON-state                       | supply path switch  | -   | 130                | -    | -                  | -              | -  | pF                         |
|                     | capacitance                    | data path switch  | -   | 16                 | -    | -                  | -              | -  | pF                         |

#### 11.1 Test circuits



#### Low-ohmic four-pole double-throw analog switch



#### 11.2 ON resistance

#### Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 13.

| Symbol                 | Parameter                       | Conditions   | T <sub>amb</sub> = | -40 °C t | o +85 °C | $T_{amb} = -40$ ° | C to +125 °C | Unit |
|------------------------|---------------------------------|--|--------------------|----------|----------|-------------------|--------------|------|
|                        |                                 |  | Min                | Typ[1]   | Max      | Min               | Max          |      |
| Supply p               | oath switch                     |  |                    |          |          |                   |              |      |
| R <sub>ON</sub>        | ON resistance                   | $V_I = GND \text{ to } V_{CC};$<br>$I_{SW} = 100 \text{ mA}; \text{ see } \underline{\text{Figure 7}}$ |                    |          |          |                   |              |      |
|                        |                                 | $V_{CC} = 1.8 \text{ V}; V_{SW} = 0 \text{ V}, 1.8 \text{ V}$  | -                  | 0.5      | 0.75     | -                 | 0.85         | Ω    |
|                        |                                 | $V_{CC} = 2.7 \text{ V}; V_{SW} = 0 \text{ V}, 2.3 \text{ V}$  | -                  | 0.45     | 0.7      | -                 | 0.8          | Ω    |
| $\Delta R_{ON}$        | ON resistance                   | $V_I = GND \text{ to } V_{CC}; I_{SW} = 100 \text{ mA}$  | <u>2]</u>          |          |          |                   |              |      |
|                        | mismatch<br>between<br>channels | $V_{CC} = 2.7 \text{ V}; V_{SW} = 0 \text{ V}$   | -                  | 0.1      | -        | -                 | -            | Ω    |
| Data pat               | h switches                      |  |                    |          |          |                   |              |      |
| R <sub>ON</sub>        | ON resistance                   | $V_I = GND \text{ to } V_{CC}; I_{SW} = 20 \text{ mA};$ see Figure 7                                   |                    |          |          |                   |              |      |
|                        |                                 | $V_{CC} = 1.8 \text{ V}; V_{SW} = 0 \text{ V}, 1.8 \text{ V}$  | -                  | 7.0      | 10.0     | -                 | 11.0         | Ω    |
|                        |                                 | $V_{CC} = 2.7 \text{ V}; V_{SW} = 0 \text{ V}, 2.3 \text{ V}$  | -                  | 6.0      | 9.5      | -                 | 10.5         | Ω    |
| $\Delta R_{\text{ON}}$ | ON resistance                   | $V_I = GND \text{ to } V_{CC}; I_{SW} = 20 \text{ mA}$   | 2]                 |          |          |                   |              |      |
|                        | mismatch<br>between<br>channels | $V_{CC} = 2.7 \text{ V}; V_{SW} = 0 \text{ V}$   | -                  | 0.2      | -        | -                 | -            | Ω    |

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25  $^{\circ}C.$ 

<sup>[2]</sup> Measured at identical V<sub>CC</sub>, temperature and input voltage.

#### Low-ohmic four-pole double-throw analog switch

#### 11.3 ON resistance test circuit and graphs

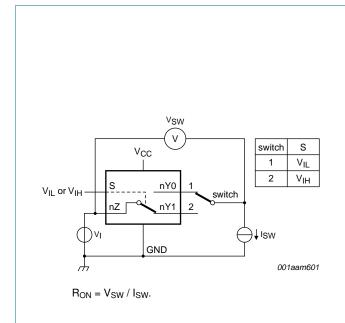
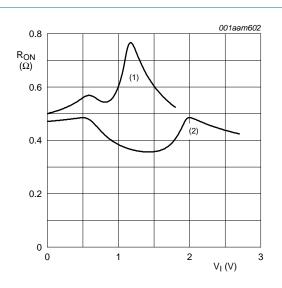
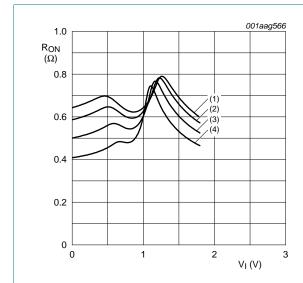


Fig 7. Test circuit for measuring ON resistance



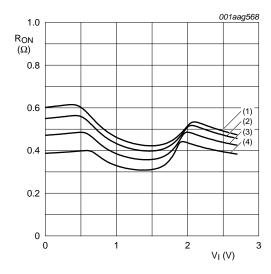
- (1)  $V_{CC} = 1.8 \text{ V}.$
- (2)  $V_{CC} = 2.7 \text{ V}.$

Fig 8. Typical ON resistance as a function of input voltage (supply path switch)



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

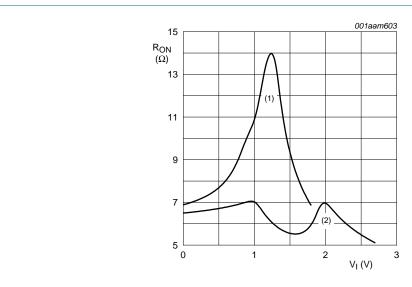
Fig 9. ON resistance as a function of input voltage;  $V_{CC} = 1.8 \text{ V (supply path switch)}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

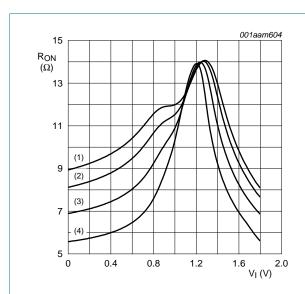
Fig 10. ON resistance as a function of input voltage;  $V_{CC} = 2.7 \text{ V (supply path switch)}$ 

#### Low-ohmic four-pole double-throw analog switch



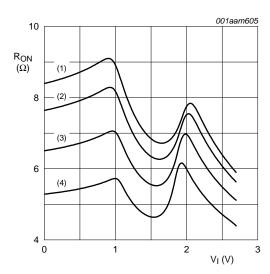
- (1)  $V_{CC} = 1.8 \text{ V}.$
- (2)  $V_{CC} = 2.7 \text{ V}.$

Fig 11. Typical ON resistance as a function of input voltage (data path switch)



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 12. ON resistance as a function of input voltage;  $V_{CC} = 1.8 \text{ V}$  (data path switch)



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 13. ON resistance as a function of input voltage;  $V_{CC} = 2.7 \text{ V (data path switch)}$ 

#### Low-ohmic four-pole double-throw analog switch

## 12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

| Symbol          | Parameter                 | Conditions                                   |     | 25 °C  |     | -40 | °C to +12      | .5 °C           | Unit                                |
|-----------------|---------------------------|--|-----|--------|-----|-----|----------------|-----------------|-------------------------------------|
|                 |                           |  | Min | Typ[1] | Max | Min | Max<br>(85 °C) | Max<br>(125 °C) |                                     |
| Supply p        | oath switch               |  | l   |        |     |     |                |                 |                                     |
| t <sub>en</sub> | enable time               | S to 1Z or 1Y0, 1Y1;<br>see Figure 14        |     |        |     |     |                |                 |                                     |
|                 |                           | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   | -   | 41     | 90  | -   | 120            | 120             | ns                                  |
|                 |                           | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | -   | 30     | 70  | -   | 80             | 90              | ns                                  |
|                 |                           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -   | 20     | 45  | -   | 50             | 55              | ns                                  |
|                 |                           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | -   | 19     | 40  | -   | 45             | 50              | ns                                  |
|                 |                           | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$   | -   | 19     | 40  | -   | 45             | 50              | ns                                  |
| dis             | disable time              | S to 1Z or 1Y0, 1Y1;<br>see Figure 14        |     |        |     |     |                |                 |                                     |
|                 |                           | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   | -   | 24     | 70  | -   | 80             | 90              | ns                                  |
|                 |                           | V <sub>CC</sub> = 1.65 V to 1.95 V           | -   | 15     | 55  | -   | 60             | 65              | ns                                  |
|                 |                           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -   | 9      | 25  | -   | 30             | 35              | ns                                  |
|                 |                           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | -   | 8      | 20  | -   | 25             | 30              | ns                                  |
|                 |                           | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$   | -   | 8      | 20  | -   | 25             | 30              | ns                                  |
| ·b-m            | break-before-make<br>time | see Figure 15                                | 2]  |        |     |     |                |                 |                                     |
|                 |                           | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   | -   | 20     | -   | 9   | -              | -               | ns                                  |
|                 |                           | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | -   | 17     | -   | 7   | -              | -               | ns                                  |
|                 |                           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -   | 13     | -   | 4   | -              | -               | ns                                  |
|                 |                           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | -   | 11     | -   | 3   | -              | -               | ns                                  |
|                 |                           | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$   | -   | 11     | -   | 2   | -              | -               | ns                                  |
| Data pat        | h switch                  |  |     |        |     |     |                |                 |                                     |
| t <sub>en</sub> | enable time               | S to nZ or nYn;<br>see Figure 14             |     |        |     |     |                |                 |                                     |
|                 |                           | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   | -   | 40     | 90  | -   | 120            | 120             | ns                                  |
|                 |                           | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | -   | 29     | 70  | -   | 80             | 90              | ns |
|                 |                           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -   | 20     | 45  | -   | 50             | 55              | ns                                  |
|                 |                           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | -   | 19     | 40  | -   | 45             | 50              | ns                                  |
|                 |                           | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$   | -   | 19     | 40  | -   | 45             | 50              | ns                                  |
| dis             | disable time              | S to nZ or nYn;<br>see Figure 14             |     |        |     |     |                |                 |                                     |
|                 |                           | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   | -   | 21     | 70  | -   | 80             | 90              | ns                                  |
|                 |                           | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | -   | 13     | 55  | -   | 60             | 65              | ns                                  |
|                 |                           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -   | 8      | 25  | -   | 30             | 35              | ns                                  |
|                 |                           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | -   | 7      | 20  | -   | 25             | 30              | ns                                  |
|                 |                           | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$   | -   | 7      | 20  | -   | 25             | 30              | ns                                  |
|                 |                           |  |     |        |     |     |                |                 |                                     |

#### Low-ohmic four-pole double-throw analog switch

 Table 9.
 Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

| Symbol           | Parameter         | Conditions                                   |  | 25 °C  |     |     | -40 °C to +125 °C |                 |    |
|------------------|-------------------|--|--|--------|-----|-----|-------------------|-----------------|----|
|                  |                   |  | Min  | Typ[1] | Max | Min | Max<br>(85 °C)    | Max<br>(125 °C) |    |
| t <sub>b-m</sub> | break-before-make | see Figure 15                                | [2]  |        |     |     |                   |                 |    |
|                  | time              | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$   | -  | 23     | -   | 9   | -                 | -               | ns |
|                  |                   | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | -  | 19     | -   | 7   | -                 | -               | ns |
|                  |                   | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$   | -  | 15     | -   | 4   | -                 | -               | ns |
|                  |                   | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$   | -  | 13     | -   | 3   | -                 | -               | ns |
|                  |                   |  | $V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$ | -      | 12  | -   | 2                 | -               | -  |

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

#### 12.1 Waveform and test circuits

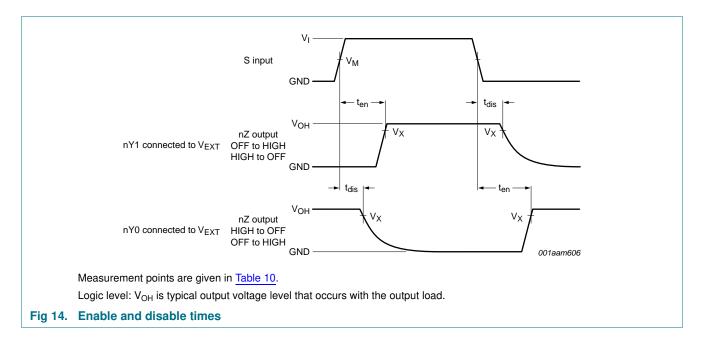
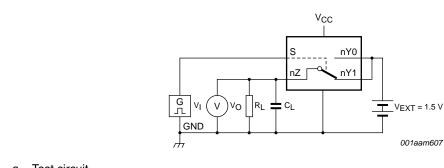


Table 10. Measurement points

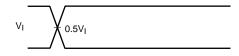
| Supply voltage  | Input              | Output             |
|-----------------|--------------------|--------------------|
| V <sub>CC</sub> | V <sub>M</sub>     | V <sub>X</sub>     |
| 1.4 V to 4.3 V  | 0.5V <sub>CC</sub> | 0.9V <sub>OH</sub> |

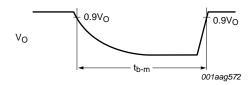
<sup>[2]</sup> Break-before-make guaranteed by design.

#### Low-ohmic four-pole double-throw analog switch



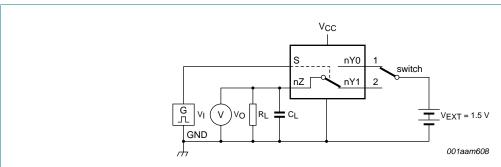
#### a. Test circuit





b. Input and output measurement points

Fig 15. Test circuit for measuring break-before-make timing



Test data is given in Table 11.

Definitions test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 16. Test circuit for measuring switching times

Table 11. Test data

| Supply voltage  | Input           |                                 | Load  |                |
|-----------------|-----------------|---------------------------------|-------|----------------|
| V <sub>CC</sub> | VI              | t <sub>r</sub> , t <sub>f</sub> | CL    | R <sub>L</sub> |
| 1.4 V to 4.3 V  | V <sub>CC</sub> | ≤ 2.5 ns                        | 35 pF | 50 Ω           |

#### Low-ohmic four-pole double-throw analog switch

### 12.2 Additional dynamic characteristics

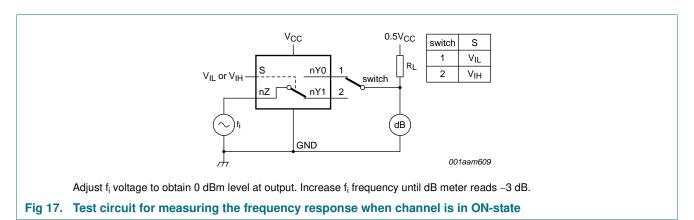
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I$  = GND or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns;  $T_{amb} = 25$  °C.

| Symbol   | Parameter  | Conditions   | Min | Тур | Max | Unit |
|--|--|--|-----|-----|-----|------|
| Data pat   | h switch   |  |     |     |     |      |
| f <sub>(-3dB)</sub> -3 dB frequency response               | $R_L = 50 \Omega$ ; see Figure 17                          | [1]  |     |     |     |      |
|  | V <sub>CC</sub> = 2.7 V to 3.6 V                           | -  | 330 | -   | MHz |      |
| $\alpha_{\text{iso}} \qquad  \text{isolation (OFF-state)}$ | $f_i = 10 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see Figure 18 | [1]  |     |     |     |      |
|  | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$                 | -  | -60 | -   | dB  |      |
| Xtalk  | crosstalk  | between switches;<br>$f_i = 10 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see Figure 19                                      | [1] |     |     |      |
|  | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$                 | -  | -60 | -   | dB  |      |
| Q <sub>inj</sub> charg                                     | charge injection   | $f_i$ = 1 MHz; $C_L$ = 0.1 nF; $R_L$ = 1 M $\Omega$ ; $V_{gen}$ = 0 V; $R_{gen}$ = 0 $\Omega$ ; see <u>Figure 20</u> |     |     |     |      |
|  |  | V <sub>CC</sub> = 2.7 V to 3.6 V   | -   | 10  | -   | рC   |

<sup>[1]</sup>  $f_i$  is biased at 0.5 $V_{CC}$ .

#### 12.3 Test circuits



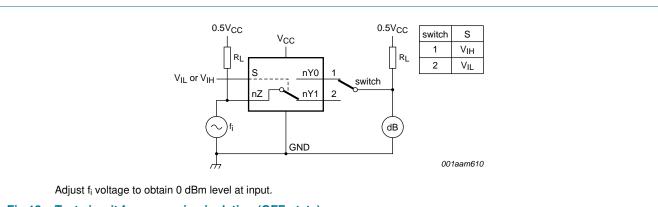
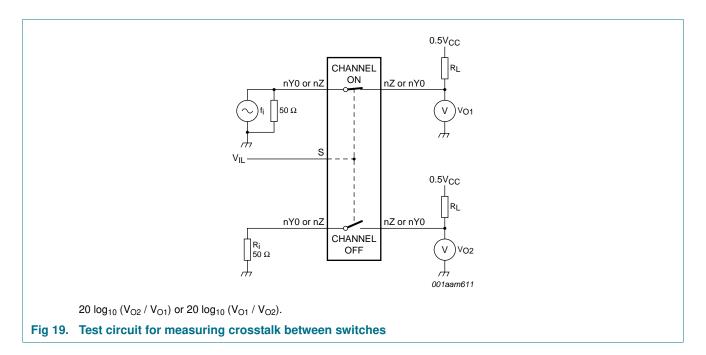
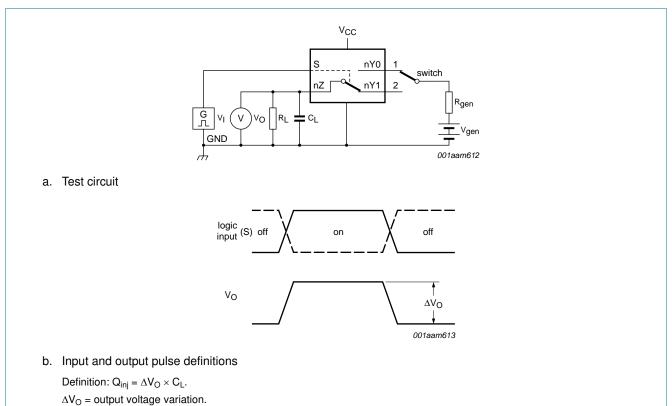


Fig 18. Test circuit for measuring isolation (OFF-state)

#### Low-ohmic four-pole double-throw analog switch





 $R_{gen}$  = generator resistance.  $V_{gen}$  = generator voltage.

Fig 20. Test circuit for measuring charge injection

#### Low-ohmic four-pole double-throw analog switch

## 13. Package outline

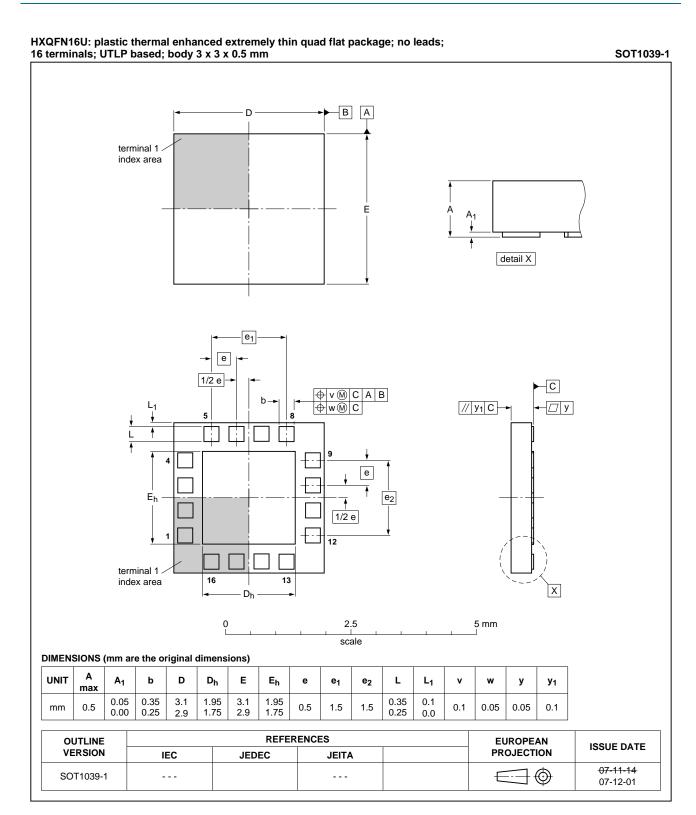


Fig 21. Package outline SOT1039-1 (HXQFN16U)

#### Low-ohmic four-pole double-throw analog switch

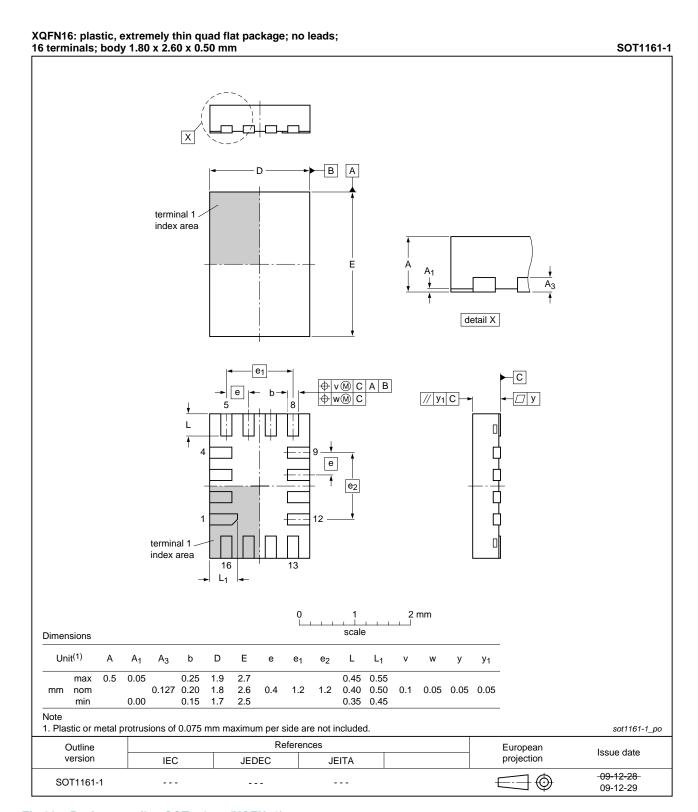


Fig 22. Package outline SOT1161-1 (XQFN16)

NX3DV2567 All information provided in this document is subject to legal disclaimers.

### Low-ohmic four-pole double-throw analog switch

### 14. Abbreviations

#### Table 13. Abbreviations

| Acronym | Description                             |
|---------|---|
| CDM     | Charged Device Model                    |
| CMOS    | Complementary Metal-Oxide Semiconductor |
| ESD     | ElectroStatic Discharge                 |
| НВМ     | Human Body Model                        |
| MM      | Machine Model                           |
| PDA     | Personal Digital Assistant              |
| TTL     | Transistor-Transistor Logic             |

## 15. Revision history

#### Table 14. Revision history

| Document ID    | Release date         | Data sheet status  | Change notice | Supersedes    |
|----------------|----------------------|--------------------|---------------|---------------|
| NX3DV2567 v.2  | 20111109             | Product data sheet | -             | NX3DV2567 v.1 |
| Modifications: | Legal pages updated. |                    |               |               |
| NX3DV2567 v.1  | 20100928             | Product data sheet | -             | -             |

#### Low-ohmic four-pole double-throw analog switch

### 16. Legal information

#### 16.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 16.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

NX3DV2567

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2011. All rights reserved.

18 of 20

#### Low-ohmic four-pole double-throw analog switch

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

#### 16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

#### 17. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

### Low-ohmic four-pole double-throw analog switch

### 18. Contents

| 1    | General description 1                   |
|------|---|
| 2    | Features and benefits                   |
| 3    | Applications                            |
| 4    | Ordering information 2                  |
| 5    | Marking 2                               |
| 6    | Functional diagram 3                    |
| 7    | Pinning information 3                   |
| 7.1  | Pinning                                 |
| 7.2  | Pin description 4                       |
| 8    | Functional description 4                |
| 9    | Limiting values 4                       |
| 10   | Recommended operating conditions 5      |
| 11   | Static characteristics 5                |
| 11.1 | Test circuits 6                         |
| 11.2 | ON resistance                           |
| 11.3 | ON resistance test circuit and graphs 8 |
| 12   | Dynamic characteristics 10              |
| 12.1 | Waveform and test circuits 11           |
| 12.2 | Additional dynamic characteristics 13   |
| 12.3 | Test circuits                           |
| 13   | Package outline                         |
| 14   | Abbreviations                           |
| 15   | Revision history 17                     |
| 16   | Legal information 18                    |
| 16.1 | Data sheet status                       |
| 16.2 | Definitions                             |
| 16.3 | Disclaimers                             |
| 16.4 | Trademarks19                            |
| 17   | Contact information 19                  |
| 18   | Contents                                |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.